

Title (en)  
LIGHT EMITTER DEVICES AND COMPONENTS WITH IMPROVED CHEMICAL RESISTANCE AND RELATED METHODS

Title (de)  
LICHTEMITTERVORRICHTUNGEN UND KOMPONENTEN MIT VERBESSERTER CHEMISCHER BESTÄNDIGKEIT UND ZUGEHÖRIGE VERFAHREN

Title (fr)  
DISPOSITIFS ET COMPOSANTS ÉLECTROLUMINESCENTS DOTÉS D'UNE RÉSISTANCE CHIMIQUE AMÉLIORÉE ET PROCÉDÉS APPARENTÉS

Publication  
**EP 3453054 A1 20190313 (EN)**

Application  
**EP 17793254 A 20170503**

Priority  
• US 201662331080 P 20160503  
• US 2017030843 W 20170503

Abstract (en)  
[origin: CN109314168A] Disclosed are LEDs and LED packages, and methods of making them, having improved resistance to infiltration by chemical entities comprising providing a coating on at least a portion of the LED chip or an LED chip package formed by co-polymerization of: (a) one or more hydrofluoroolefin monomer(s) selected from the group consisting of tetrafluoroethylene, hydrofluoroethylenes, hydrofluoropropenes, hydrofluorobutenes, hydrofluoropentenes and combinations of these; (b) optionally one or more chlorofluoroethylene monomers; (c) optionally one or more vinyl ester monomer(s); and (d) optionally one or more vinyl ether monomer(s), wherein at least a portion of said vinyl ether monomer is preferably a hydroxyl group-containing vinyl ether monomer and preferably at least one of (b) and (d) is present.

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